

Mounting printed circuit boards

The company's products are best known for their performance and high-quality. The attainment of such peak performance parameters is fully dependant on the components and technology we use in production. To maintain this level of quality RACOM has invested in a complete line for mounting PCBs with double-sided surface and hybrid assembly in accordance with the RoHS directive.

Facilities at our special worksite in Blansko for mounting PCBs using SMT technology are also available to external customers.



Technology and services

- **Soldering paste and glue** is applied by printing through quality metal stencils on a SIGMAPRINT screen printer from SMTECH with a wide range of adjustable and reproducible parameters.
- Automatic mounting on the MYDATA mounting machine with more than 190 basic positions for mounting material, high mounting precision, optical guidance, optical centring and a capability of mounting 16000 components per hour.
- **Melting of the soldering paste**, or hardening of the glue, in a HELLER eight- zone hot-air furnace with the possibility of precision adjustment of the melting profile with regard to all materials used soldering paste, components, glue, PCBs.
- For soldering glued SMD components or pin components with lead or lead-free solder two SEHO wave solder
 machines are available, equipped with a spraying fluxer and double-wave system for reliable soldering of a
 wide range of components.
- For mounting conventional components and non-standard SMD components the centre is equipped with manual workstations with the necessary manipulators and optics.
- Additional services offered
 - Technical-technological consultation
 - PCB manufacture
 - · Production of stencils for printing soldering paste or glue
 - Provision of material for production





